MOSFET – N-Channel **QFET**[®]

600 V, 0.3 A, 11.5 Ω

FQN1N60C

Description

This N-Channel enhancement mode power MOSFET is produced using ON Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.

Features

- 0.3 A, 600 V, $R_{DS(on)} = 11.5 \Omega$ (Max.) @ $V_{GS} = 10$ V, $I_D = 0.15 A$
- Low Gate Charge (Typ. 4.8 nC)
- Low Crss (Typ. 3.5 pF)
- 100% Avalanche Tested

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C unless otherwise noted)

,						
Symbol	Parameter	Value	Unit			
V _{DSS}	Drain to Source Voltage	600	V			
V _{GSS}	Gate to Source Voltage		±30	V		
Ι _D	Drain Current Continuous (T _C = 25°C) Continuous (T _C = 100°C)		0.3 0.18	A		
I _{DM}	Drain Current – Pulsed	(Note 1)	1.2	А		
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	33	mJ		
I _{AR}	Avalanche Current	(Note 1)	0.3	А		
E _{AR}	Repetitive Avalanche Energy	(Note 1)	0.3	mJ		
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	4.5	V/ns		
P _D	Power Dissipation $(T_A = 25^{\circ}C)$ $(T_L = 25^{\circ}C)$ Derate above 25°C		1 3 0.02	W W W/°C		
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C		
ΤL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds		300	°C		

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. L = 59 mH, I_{AS} = 1.1 A, V_{DD} = 50 V, R_G = 25 Ω , Starting T_J = 25°C. 3. $I_{SD} \le 0.3$ A, di/dt ≤ 200 A/ μ s, $V_{DD} \le BV_{DSS}$, Starting T_J = 25°C.

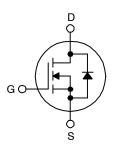


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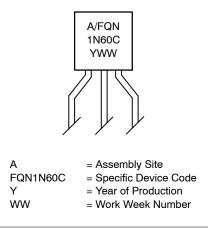
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TO-92 4.75x4.80 CASE 135AV



MARKING DIAGRAM



ORDERING INFORMATION

Device	Package	Shipping
FQN1N60CTA	TO-92 3LD	2000 / Fan-Fold

THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
$R_{ ext{ heta}JL}$	Thermal Resistance, Junction-to-Lead, Max. (Note	i) 50	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max. (Note	i) 140	

ELECTRICAL CHARACTERISTICS (T_C = 25°C, unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
OFF CHAR	ACTERISTIC					
BV _{DSS}	Drain to Source Breakdown Voltage	$I_D = 250 \ \mu A, \ V_{GS} = 0 \ V$	600	-	-	V
ΔBV_{DSS} / ΔT_{J}	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, Referenced to 25°C	-	0.6	-	V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 600 V, V _{GS} = 0 V	-	-	50	μA
		$V_{DS} = 480 \text{ V}, \text{ T}_{\text{C}} = 125^{\circ}\text{C}$	_	-	250	1
I _{GSSF}	Gate to Body Leakage Current, Forward	$V_{GS} = 30 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$	_	-	100	nA
I _{GSSR}	Gate to Body Leakage Current, Reverse	$V_{GS} = -30 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$	_	-	-100	nA
ON CHARA	ACTERISTICS			-	-	
V _{GS(th)}	Gate Threshold Voltage	$V_{GS}=V_{DS},I_{D}=250\;\mu\text{A}$	2.0	-	4.0	V
R _{DS(on)}	Static Drain to Source On-Resistance	V _{GS} = 10 V, I _D = 0.15 A	_	9.3	11.5	Ω
9 FS	Forward Transconductance	$V_{DS} = 40 \text{ V}, \text{ I}_{D} = 0.3 \text{ A}$	_	0.75	-	S
DYNAMIC	CHARACTERISTICS	·				
C _{iss}	Input Capacitance	V_{DS} = 25 V, V_{GS} = 0 V, f = 1.0 MHz	-	130	170	pF
C _{oss}	Output Capacitance	1 1	_	19	25	pF
C _{rss}	Reverse Transfer Capacitance			3.5	6	pF
SWITCHIN	G CHARACTERISTICS			-	-	
t _{d(on)}	Turn-On Delay Time	V_{DD} = 300 V, I_{D} = 1.1 A, R_{G} = 25 Ω	-	7	24	ns
t _r	Turn–On Rise Time	(Note 4)	-	21	52	ns
t _{d(off)}	Turn-Off Delay Time		_	13	36	ns
t _f	Turn-Off Fall Time		_	27	64	ns
Qg	Total Gate Charge	V_{DS} = 480 V, I _D = 1.1 A, V _{GS} = 10 V	_	4.8	6.2	nC
Q _{gs}	Gate to Source Charge	(Note 4)	_	0.7	-	nC
Q _{gd}	Gate to Drain Charge]	-	2.7	-	nC
	URCE DIODE CHARACTERISTICS AND M	IAXIMUM RATINGS		-	-	-
۱ _S	Maximum Continuous Drain to Source Diode Forward Current		_	-	0.3	Α

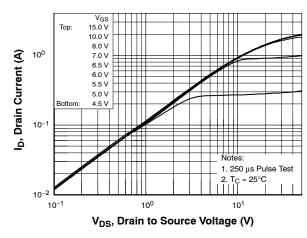
Maximum Continuous Drain to Source Diode Forward Current		-	-	0.3	A
Maximum Pulsed Drain to Source Diode Forward Current		-	-	1.2	А
Drain to Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{S} = 0.3 \text{ A}$	-	-	1.4	V
Reverse Recovery Time	V_{GS} = 0 V, I_S = 1.1 A, dI_F/dt = 100 A/ μs	-	190	-	ns
Reverse Recovery Charge]	-	0.53	-	μC
	Maximum Pulsed Drain to Source Diode F Drain to Source Diode Forward Voltage Reverse Recovery Time	$\label{eq:rescaled} \begin{array}{l} \mbox{Maximum Pulsed Drain to Source Diode Forward Current} \\ \mbox{Drain to Source Diode Forward Voltage} & V_{GS} = 0 \ V, \ I_S = 0.3 \ A \\ \mbox{Reverse Recovery Time} & V_{GS} = 0 \ V, \ I_S = 1.1 \ A, \ dI_F/dt = 100 \ A/\mu s \end{array}$	Maximum Pulsed Drain to Source Diode Forward Current - Drain to Source Diode Forward Voltage V _{GS} = 0 V, I _S = 0.3 A - Reverse Recovery Time V _{GS} = 0 V, I _S = 1.1 A, dI _F /dt = 100 A/µs -	Maximum Pulsed Drain to Source Diode Forward Current - - Drain to Source Diode Forward Voltage $V_{GS} = 0 V$, $I_S = 0.3 A$ - - Reverse Recovery Time $V_{GS} = 0 V$, $I_S = 1.1 A$, $dI_F/dt = 100 A/\mu s$ - 190	Maximum Pulsed Drain to Source Diode Forward Current1.2Drain to Source Diode Forward Voltage $V_{GS} = 0 \text{ V}, I_S = 0.3 \text{ A}$ 1.4Reverse Recovery Time $V_{GS} = 0 \text{ V}, I_S = 1.1 \text{ A}, dI_F/dt = 100 \text{ A/}\mu\text{s}$ -190-

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

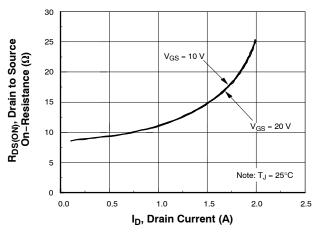
4. Essentially independent of operating temperature.

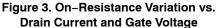
Essentially independent of operating temperature.
 Reference point of the R_{θJL} is the drain lead.
 When mounted on 3"x4.5" FR-4 PCB without any pad copper in a still air environment (R_{θJA} is the sum of the junction-to-case and case-to-ambient thermal resistance. R_{θCA} is determined by the user's board design)

TYPICAL CHARACTERISTICS









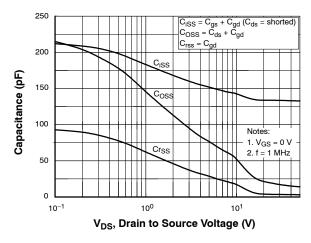


Figure 5. Capacitance Characteristics

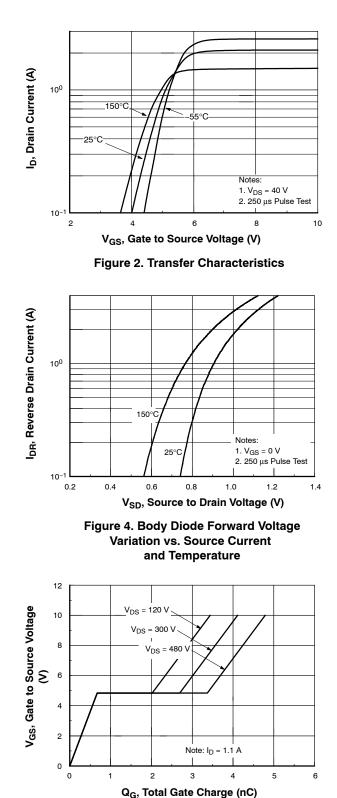


Figure 6. Gate Charge Characteristics

TYPICAL CHARACTERISTICS (Continued)

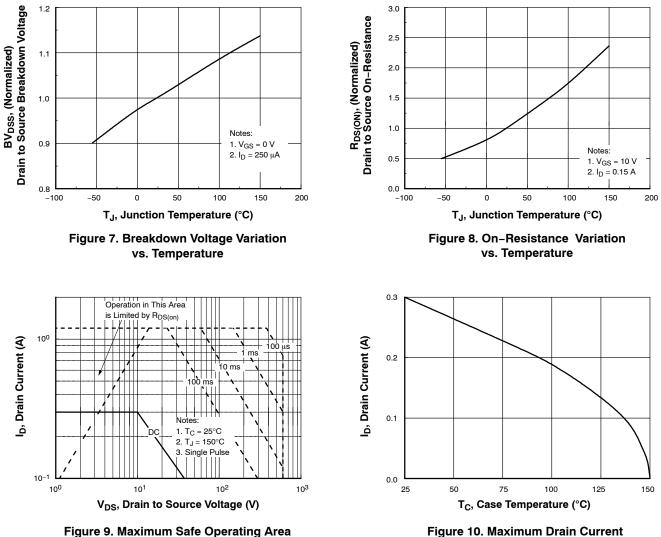


Figure 10. Maximum Drain Current vs. Case Temperature

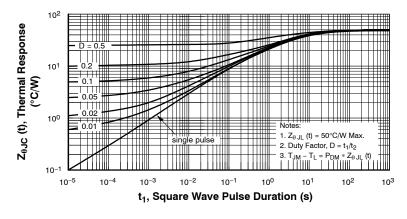
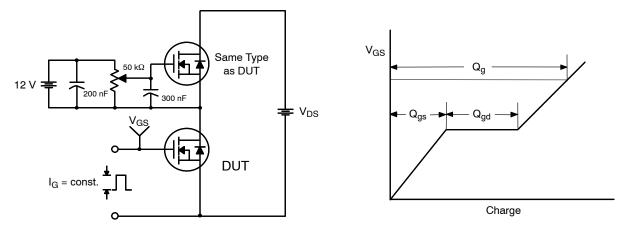


Figure 11. Transient Thermal Response Curve





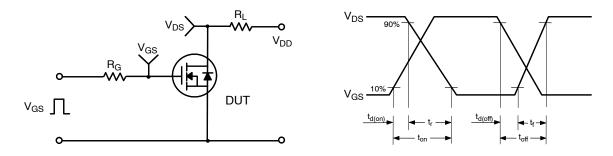


Figure 13. Resistive Switching Test Circuit & Waveforms

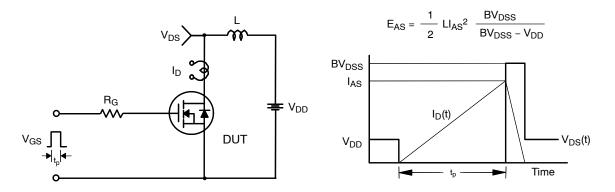


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms

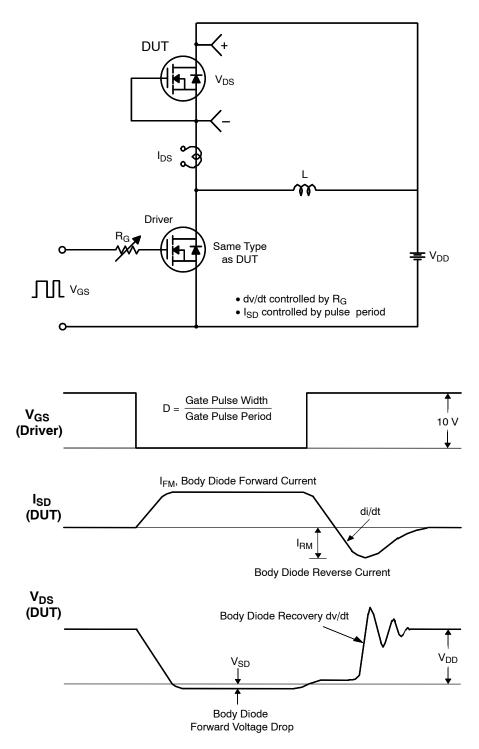
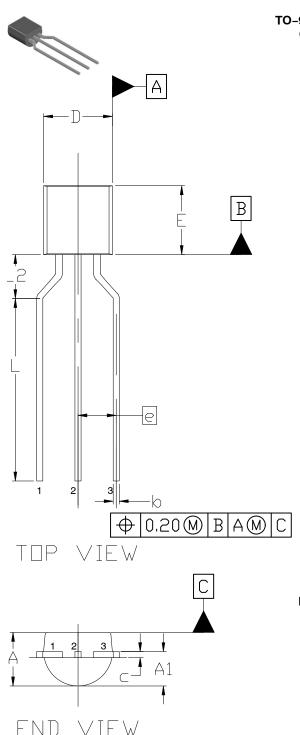


Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS





TO-92 3LD 4.75x4.80 CASE 135AV ISSUE O

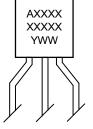
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NDTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, GATE REMAINS AND TIE BAR PROTRUSIONS.

	MILLIMETERS			
DIM	MIN.	NDM.	MAX.	
А	3.05	3.60	4.19	
A1	2.13	2.50	2.88	
Q	0.36	0.46	0.56	
C	0.30	0.40	0.52	
D	4.32	4.75	5.20	
E	4.32	4.80	5.33	
e	2.54 BSC			
L	10.50	11.75	13.00	
L2	2.54		3.44	

GENERIC MARKING DIAGRAM*



XXXX = Specific Device Code A = Assembly Location

= Year

Y

WW = Work Week

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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